

EGF1A, EGF1B, EGF1C, EGF1D

Vishay General Semiconductor

Surface Mount Glass Passivated Ultrafast Rectifier

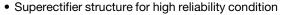
SUPERECTIFIER®



DO-214BA (GF1)

PRIMARY CHARACTERISTICS						
I _{F(AV)}	1.0 A					
V _{RRM}	50 V, 100 V, 150 V, 200 V					
I _{FSM} 30 A						
t _{rr}	50 ns					
V _F	1.0 V					
T _J max.	175 °C					
Package	DO-214BA (GF1)					
Diode variations Single die						

FEATURES





RoHS

• Cavity-free glass-passivated junction

Ideal for automated placement

Ultrafast reverse recovery time

· Low switching losses, high efficiency

• High forward surge capability

• Meets environmental standard MIL-S-19500

 Meets MSL level 1, per J-STD-020, LF maximum peak of 250 °C

AEC-Q101 qualified

 Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

TYPICAL APPLICATIONS

For use in high frequency rectification and freewheeling application in switching mode converters and inverters for consumer, computer, automotive and telecommunication.

MECHANICAL DATA

Case: DO-214BA, molded epoxy over glass body Molding compound meets UL 94 V-0 flammability rating Base P/N-E3 - RoHS-compliant, commercial grade Base P/NHE3 - RoHS-compliant, AEC-Q101 qualified

Terminals: Matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

E3 suffix meets JESD 201 class 1A whisker test, HE3 suffix meets JESD 201 class 2 whisker test

Polarity: Color band denotes cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT	
Device marking code		EA	EB	EC	ED		
Maximum repetitive peak reverse voltage	V_{RRM}	50	100	150	200	V	
Maximum RMS voltage	V _{RMS}	35	70	105	140	V	
Maximum DC blocking voltage	V _{DC}	50	100	150	200	V	
Maximum average forward rectified current at T _L = 125 °C	I _{F(AV)}		Α				
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30				А	
Operating junction and storage temperature range	T _J , T _{STG}	- 65 to + 175				°C	

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ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)								
PARAMETER	TEST CONDITIONS		SYMBOL	EGF1A	EGF1B	EGF1C	EGF1D	UNIT
Maximum instantaneous forward voltage	1.0 A		V _F ⁽¹⁾	1.0				V
Maximum DC reverse current		T _A = 25 °C	I _R ⁽¹⁾	5.0			μA	
at rated DC blocking voltage		T _A = 125 °C	'R ''		5	0		μΑ
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	50			ns	
Typical junction capacitance	4.0 V, 1 MHz		CJ	15			pF	

Note

⁽¹⁾ Pulse test: 300 µs pulse width, 1 % duty cycle

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER SYMBOL EGF1A EGF1B EGF1C EGF1D					UNIT	
Typical thermal registeres	R _{0JA} (1)	85			°C/W	
Typical thermal resistance		30				C/VV

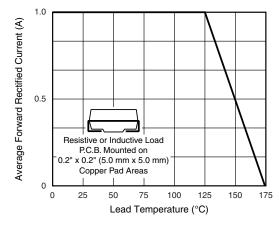
Note

⁽¹⁾ Thermal resistance from junction to ambient and from junction to lead, PCB mounted on 0.2" x 0.2" (5.0 mm x 5.0 mm) copper pad areas

ORDERING INFORMATION (Example)							
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE			
EGF1D-E3/67A	0.104	67A	1500	7" diameter plastic tape and reel			
EGF1D-E3/5CA	0.104	5CA	6500	13" diameter plastic tape and reel			
EGF1DHE3/67A (1)	0.104	67A	1500	7" diameter plastic tape and reel			
EGF1DHE3/5CA (1)	0.104	5CA	6500	13" diameter plastic tape and reel			

Note

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise specified)





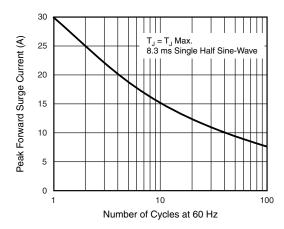


Fig. 2 - Maximum Non-Repetitive Peak Forward Surge Current

⁽¹⁾ AEC-Q101 qualified





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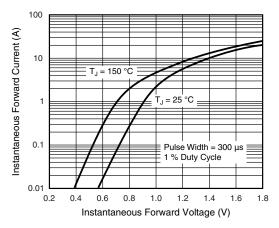
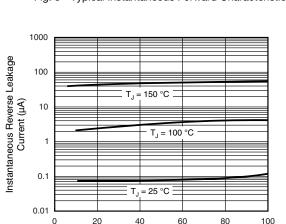


Fig. 3 - Typical Instantaneous Forward Characteristics



Percent of Rated Peak Reverse Voltage (%) Fig. 4 - Typical Reverse Leakage Characteristics

0.066 (1.68)

0.040 (1.02)

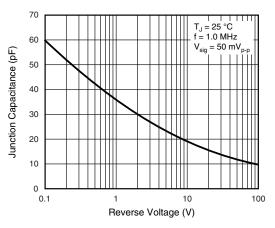


Fig. 5 - Typical Junction Capacitance

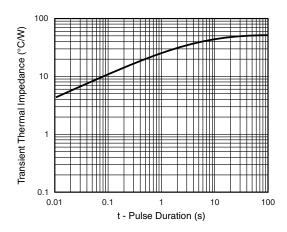


Fig. 6 - Typical Transient Thermal Impedance

Mounting Pad Layout

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

0.187 (4.75) 0.167 (4.24)

DO-214BA (GF1)

0.076 (1.93) 0.066 (1.68) MAX. MIN. 0.060 (1.52) MIN. 0.220 (5.58)



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